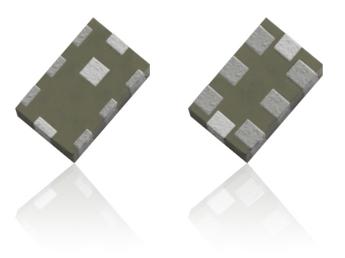


Specification

Part No.	:	LLP.2500.X.B.30
Description	:	LTCC Low Pass Filter for 2500MHz
		Bandwidth 100MHz
Features	:	Cutoff Frequency 2450 MHz
		Low Insertion Loss
		Low Pass Band Ripple
		High Attenuation
		Ultra-Compact, Low Profile SMT Package
		Dims: 2.9 x 1.25 x 0.95mm





1. Introduction

Taoglas are utilizing their deep understanding of the RF component design and manufacturing process to provide high-quality, small-form-factor, cost-effective and easy to implement RF filters. The Taoglas Filters Division will feature a range of off-the-shelf filters for a variety of applications, including filters for emerging license free bands used for IoT and for GPS L1/L2 and L1/L5 applications. We can also work with customers to develop bespoke filter solutions.

Taoglas LTCC filters are designed to be used in wireless transmitters or receivers. They feature low insertion loss and provide good rejection of unwanted signals at harmonic frequencies for improved system performance. The product is manufactured as a multi-layer monolithic ceramic structure which provides high reliability in a lightweight, low-profile, industrial standard SMT package.

These small part sizes allow for high density PCB layout, provide excellent solderability, and allow for easy visual inspection capability.

The LBP.2500.X.B.30 is a standard Taoglas product but can be customized for specific customer needs. For more information please contact your regional sales office.



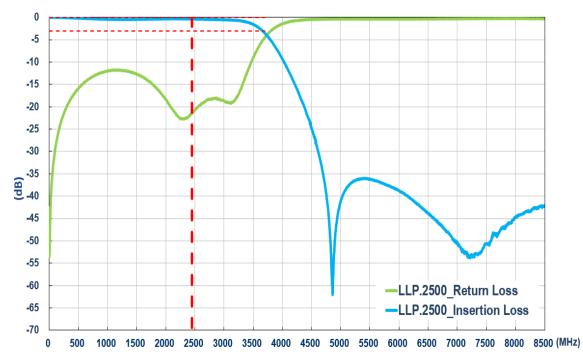
2. Specification

ELECTRICAL					
Cutoff Frequency (Fo)	2450 MHz				
Insertion Loss	0.5 dB max				
Passband Ripple	0.5 dB max				
Return Loss	< -10 dB				
Attenuation	> 20 dB @ 4500 MHz ~ 5000 MHz				
Attenuation	> 30dB @ 5000 MHz ~ 8500 MHz				
In/Out Impedance	50 Ω				
Power Dissipation	1.0 W min.				
MECHANICAL					
Dimension	2.9 x 1.25 x 0.95mm (L x W x H)				
Material	Ceramic				
Finish	Ag plated				
ENVIRONMENTAL					
Operating Temperature	-40°C to 85°C				
Storage Temperature	-40°C to 85°C				
Moisture Sensitivity Level (MSL)	3 (168 Hours)				

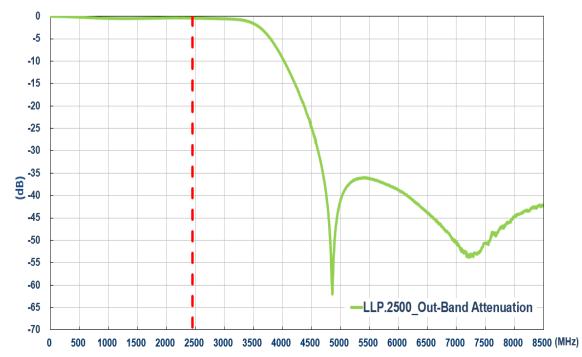


3. Characteristics Curve

3.1. Pass Band Return & Insertion Loss



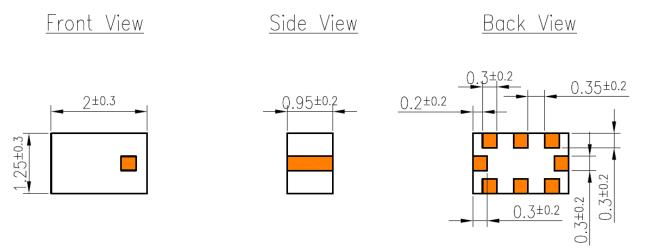






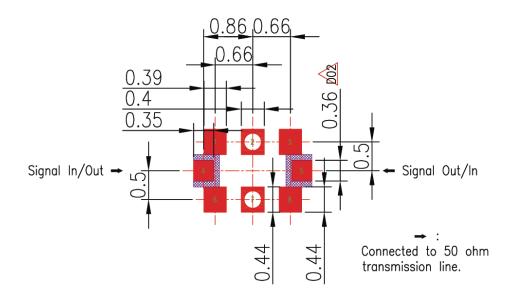
4. Mechanical Drawings (Unit: mm)

4.1. Antenna Drawing

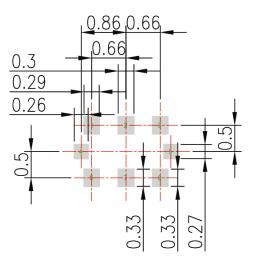




4.2. Recommended PCB Layout 4.2.1. Top Copper



4.2.2. Top Solder Paste

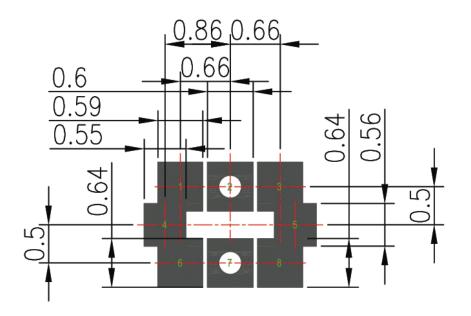


NOTE:

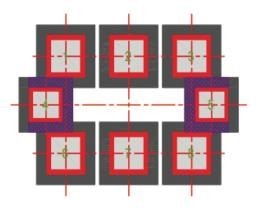
- 1. Ag Plated area
- 2. Solder Mask area
- 3. Copper area
- 4. Paste area
- 5. Copper Keepout Area
- 6. Any vias in pads should be either filled or tented to prevent solder from wicking away from the pad during reflow.
- 7. The dimension tolerances should follow standard PCB manufacturing guidelines



4.2.3. Top Solder Mask



4.2.4. Composite Diagram



NOTE:

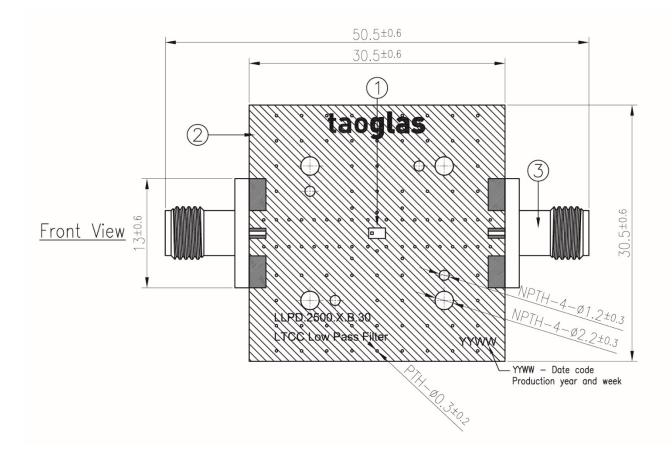
- 1. Ag Plated area
- 2. Solder Mask area
- 3. Copper area
- 4. Paste area

- 5. Copper Keepout Area
- wicking away from the pad during reflow. 7. The dimension tolerances should follow standard PCB manufacturing guidelines

6. Any vias in pads should be either filled or tented to prevent solder from



4.3. Evaluation Board

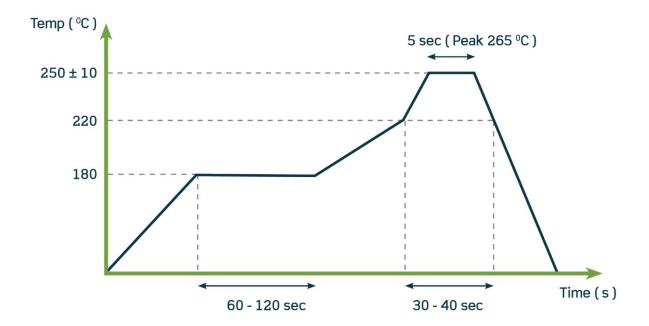


	Name	Material	Finish	QTY
1	Filter (2x1.25x0.95mm)	Ceramic	Clear	1
2	PCB	Composite 1.0t	Black	1
3	SMA(F) ST	Brass	Au Plated	2



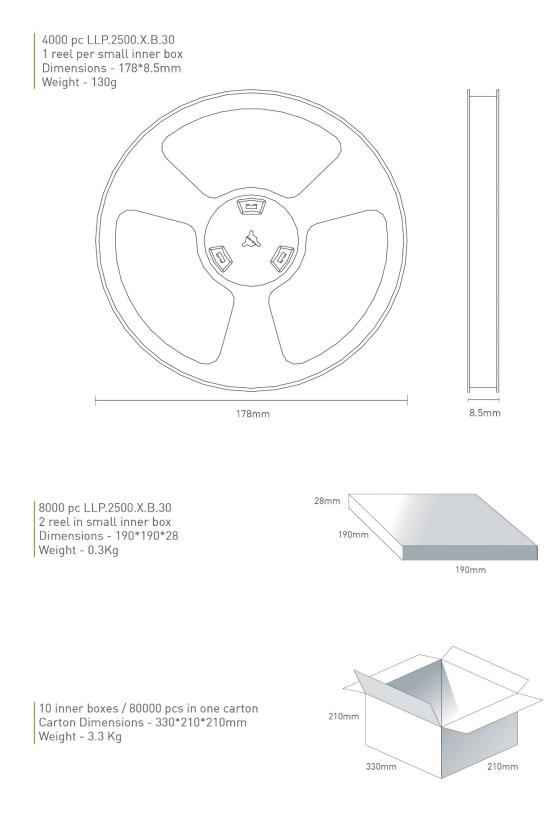
5. Recommended Reflow Soldering Profile

Phase	Profile Features	Maximum	
	Temperature Min	150 °C	
Preheat	Temperature Max	180 °C	
	Duration	60-120 sec	
Ramp-Up	Avg. Ramp up rate	3 °C/sec (max)	
Reflow	Temperature	220 °C	
	Duration	30-40 sec	
Peak	Temperature	265 °C	
	Duration	5 sec Max	
Ramp Down	Avg. Ramp down rate	3 °C/sec (max)	





6. Packaging





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